

**Features**

- Manufactures blanks for fine and miniature crystal units.

**Applications**

- Blanks for crystal units.

**Wafers for blanks**

Model	Basic Frequency	Dimensions (mm)	Thickness	Surface Finish	Main Face Angle
1" Rectangular plate	—	25.4×25.4	0.045 min.	#4000/ polish	Angle Specified±15"
2" Rectangular plate	—	50.8×50.8	0.085 min.	#4000/ polish	Angle Specified±15"
3" Rectangular plate	—	76.2×76.2	0.200 min.	#4000/ polish	Angle Specified±60"

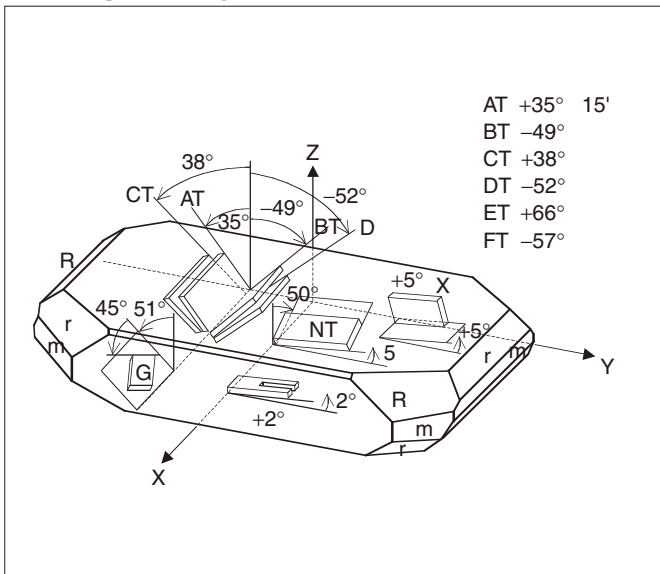
\* Size and thickness other than above shall be studied upon request.

**Blanks**

Model	Basic Frequency	Dimensions (mm)	Surface Finish	Main Face Angle	Contour Finish
L1.4 Blank	20MHz to 80MHz	Long Side 1.4	#4000/ polish	Angle Specified±15"	#4000
L2.0 Blank	12MHz to 80MHz	Long Side 2.0	#4000/ polish	Angle Specified±15"	#4000
L3.5 Blank	10MHz to 80MHz	Long Side 3.5	#4000/ polish	Angle Specified±15"	#4000

\* Size and thickness other than above shall be studied upon request.

**Cut Angle of Crystal Blank**



**AT Cut Plate**

